

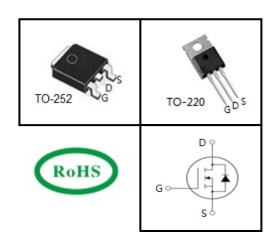
## **30V N-Channel Trench MOSFET**

#### **FEATURES**

- Trench Power MOSFET Technology
- Low R<sub>DS(ON)</sub>
- Low Gate Charge
- Optimized For Fast-switching Applications

#### **APPLICATIONS**

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial



Device Marking and Package Information			
Device	Package	Marking	
TTD160N03GT	TO-252	160N03GT	
TTP160N03GT	TO-220	160N03GT	

<b>Absolute Maximum Ratings</b> $T_C = 25^{\circ}C$ , unless otherwise noted			
Dozomator	Symbol	Value	Unit
Parameter		TO-252, TO-220	
Drain-Source Voltage (V <sub>GS</sub> = 0V)	V <sub>DSS</sub>	30	V
Continuous Drain Current	I <sub>D</sub>	160	А
Pulsed Drain Current (note1)	I <sub>DM</sub>	640	А
Gate-Source Voltage	$V_{GSS}$	±20	V
Single Pulse Avalanche Energy (note2)	E <sub>AS</sub>	277	mJ
Avalanche Current	I <sub>As</sub>	43	А
Power Dissipation (T <sub>C</sub> = 25°C)	$P_{D}$	143	W
Operating Junction and Storage Temperature Range	$T_J,T_stg$	-55~+175	°C

Thermal Resistance				
Dovometer	Oh. ad	Value	l lmit	
Parameter	Symbol	TO-252, TO-220	Unit	
Thermal Resistance, Junction-to-Case	R <sub>thJC</sub> 1.05		14001	
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	60	K/W	

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Parameter	Symbol	Tool Conditions	Value			
		Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0V, I_{D} = 250\mu A$	30			V
Zees Oats Valtage Dusin Occurrent		$V_{DS} = 30V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30V, V_{GS} = 0V, T_{J} = 125^{\circ}C$			100	μA
Gate-Source Leakage	$I_{\rm GSS}$	$V_{GS} = \pm 20V$			±100	nA
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.7	2.4	V
Drain Course On Desigtance (Nate2)	D	$V_{GS} = 10V, I_D = 20A$		1.6	2.1	mΩ
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A		2.1	3.0	mΩ
Forward Transconductance (Note3)	g <sub>fs</sub>	$V_{DS} = 10V, I_{D} = 20A$		42.6		S
Dynamic						
Input Capacitance	C <sub>iss</sub>	V - 0V		9300		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0V,$ $V_{DS} = 25V,$		904		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0MHz		813		
Total Gate Charge	$Q_g$			160		
Gate-Source Charge	$Q_{gs}$	$V_{DD} = 15V, I_{D} = 30A,$ $V_{GS} = 10V$		18		nC
Gate-Drain Charge	$Q_{gd}$	93 -		34		
Turn-on Delay Time	t <sub>d(on)</sub>			27		
Turn-on Rise Time	t <sub>r</sub>	$V_{DD} = 20V, I_{D} = 30A,$		25		
Turn-off Delay Time	t <sub>d(off)</sub>	$R_{G} = 3\Omega$		90		ns
Turn-off Fall Time	t <sub>f</sub>			40		
Drain-Source Body Diode Characteris	stics					
Continuous Body Diode Current	I <sub>s</sub>	T 0500			160	
Pulsed Diode Forward Current	I <sub>SM</sub>	$T_{\rm C} = 25^{\rm o}{\rm C}$			640	Α
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25^{\circ}\text{C}, I_{SD} = 30\text{A}, V_{GS} = 0\text{V}$			1.2	٧
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 30A,		43		ns
Reverse Recovery Charge	Q <sub>rr</sub>	$di_{F}/dt = 100A/\mu s$		40		nC

### Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2.  $I_{AS}$  = 43A,  $V_{DD}$  = 50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25 $^{\circ}$ C
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 1%



### **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

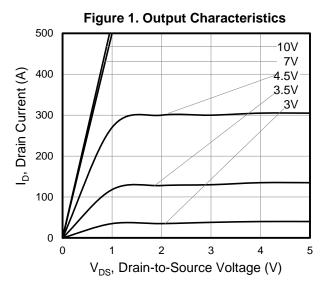


Figure 3. On-Resistance vs. Drain Current

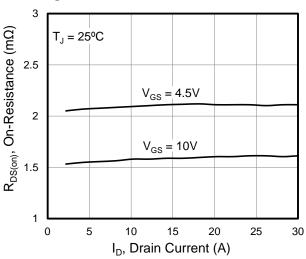


Figure 5. Gate Charge

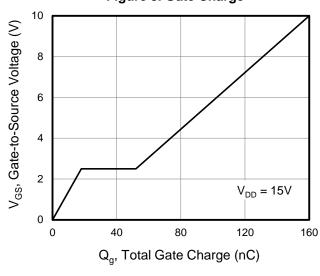


Figure 2. Transfer Characteristics

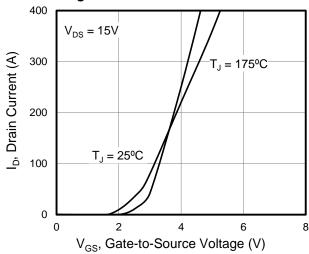


Figure 4. Capacitance

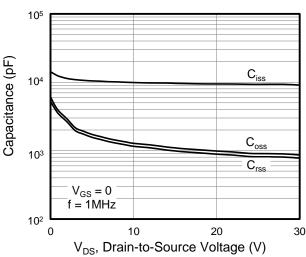
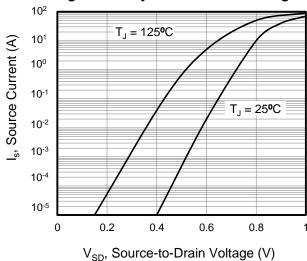


Figure 6. Body Diode Forward Voltage





## **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

Figure 7. On-Resistance vs.

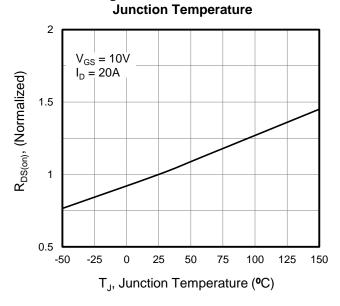


Figure 8. Threshold Voltage vs. Junction Temperature

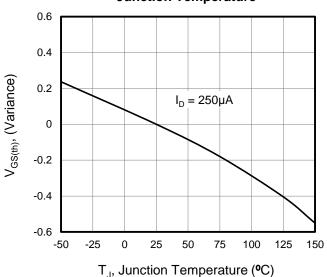
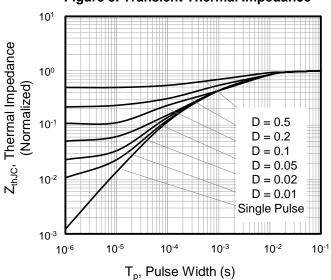


Figure 9. Transient Thermal Impedance



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Figure A: Gate Charge Test Circuit and Waveform

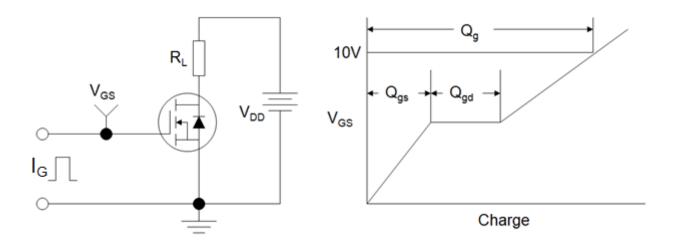


Figure B: Resistive Switching Test Circuit and Waveform

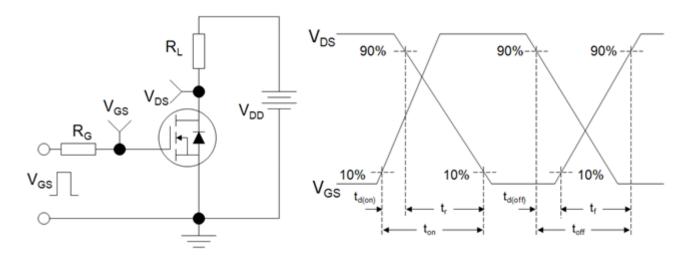
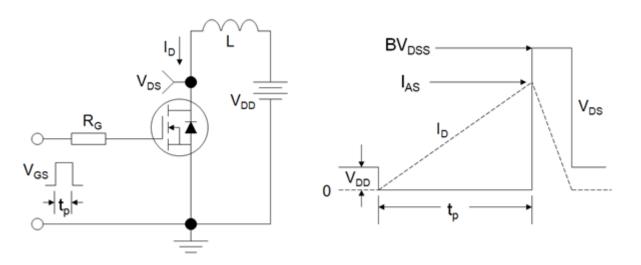
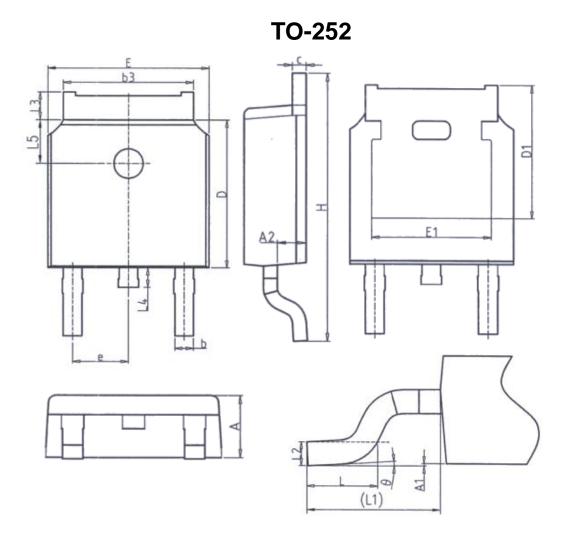


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



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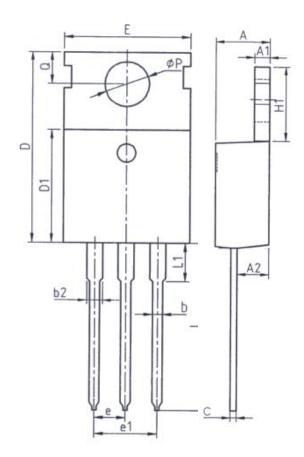


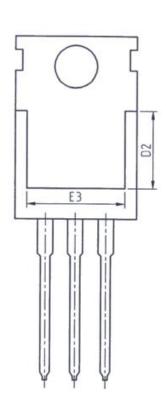
Unit: mm			
Symbol	Min.	Max.	
Α	2. 20	2. 40	
A1	0.00	0. 20	
A2	0. 97	1. 17	
b	0. 68	0.90	
b3	5. 20	5. 50	
С	0. 43	0. 63	
D	5. 98	6. 22	
D1	D1 5. 30REF		
E	6. 40	6. 80	
E1	4. 63	_	

Unit: mm			
Symbol	Min.	Max.	
е	2. 28	6BSC	
Н	9. 40	10.50	
L	1. 38	1. 75	
L1	2. 90REF		
L2	0. 51BSC		
L3	0.88	1. 28	
L4	_	1.00	
L5	1. 65	1. 95	
θ	0°	8°	



# **TO-220**





Unit: mm		
Symbol	Min.	Max.
Α	4. 37	4. 77
A1	1. 25	1. 45
A2	2. 20	2. 60
b	0. 70	0. 95
b2	1. 17	1. 47
С	0.40	0. 65
D	15. 10	16. 10
D1	8. 80	9. 40
D2	5. 50	_

Unit: mm			
Symbol	Min.	Max.	
E	9. 70	10. 30	
E3	7. 00	-	
е	2. 54BSC		
e1	5. 08BSC		
H1	6. 25	6. 85	
L	12. 75	13.80	
L1	-	3. 40	
Р	3. 40	3. 80	
Q	2. 60	3. 00	



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